ABSOCIATION CONNECTING ELECTRONICS INDUSTRIES INDUSTRIES INDUSTRIES	C. Bannockb	urn. Illinois. A	Il rights reserved un ntions.	nder both	This docume level parts, t	ent is a declaration en	n of the subst compasses all	ances within the manuf lower level materials	acturer liste or which the	d item. Note: if e manufacturer	the item is an as has engineering	ssembly with lower responsibility.	
					Type * Declaration Class * ute Class 6 - RoHS Yes/No, Homogeneous Materia				aterials and	ials and Mfg Information			
Supplier Information													
Company name* Company			pany unique ID			Unique ID Authority				Response Date*			
onsemi								2025-09-13					
Contact Name Title - Contact			ct	P		Phone - Contact*			Emai	Email - Contact*			
Product-Env-Stewards Product Enviro			iro Compliance		NA			Prod	Product-Env-Stewards@onsemi.com				
Authorized Representative* Title - Represent			entative		Phone - Representative*			Emai	Email - Representative*				
Product-Env-Stewards Product Env			t Enviro Compliance		NA			Prod	Product-Env-Stewards@onsemi.com				
Requester Item Number	Mfr Item Number		Mfr Item Name			Effective Date	Version	Manufacturing Si	e	Weight*	UOM	Unit Type	
	MC1406	MC14067BDWG LC		LOG CMOS MLTIPLXR 16CHAN		2025-09-13		PH1	PH1		mg	Each	
Manufacturing Proccess Informati	on		·			•				-			
Terminal Plating / Grid Array Mate	erial Terminal Base A		lloy J-STD-020 MSL Rati		Rating	Peak Process Body Temperature Max Time		erature Max Time at	Peak Tempe	ak Temperature Number of Reflow Cycles		cles	
Matte Tin (Sn) - annealed CU Alloy		3			260	C	30	sec	conds 3				
Comments													
ATTENTION: MSL 3 Rated item requires	Bake and D	ry Pack (after	electrical test)										
or more information regarding material c	omposition	please refer to	page 3										

RoHS Material Composition Declaration				Declaration Type *	Detailed					
Directive 2015/863/EU amending RoHS Directive 2011/65/EU	(Pb), Mercury (Hg), Hexavalent Chror	efinition: Quantity limit of 0.01% by mass (100 PPM) in homogeneous material for Cadmium and quantity limit of 0.1% by mass (1000 PPM) in homogeneous material for: Lead ercury (Hg), Hexavalent Chromium (Cr6+), Polybrominated Biphenyls (PBB), Polybrominated Diphenyl Ethers (PBDE), and Bis(2-ethylhexyl) phthalate (DEHP), Benzyl-butyl (BBP), Dibutyl phthalate (DBP), Diisobutyl phthalate (DIBP).								
cadmium, hexavalentchromium, polybrominate contains a RoHS restricted substance inexcess encompass all such components. Supplier certif as of the date that Supplier completes this form Company acknowledges that Supplier may hav independently verified information provided by certification in this paragraph. If the Company a	ed biphenyls and/or polybrominated dip of an applicable quantity limit, please ir ies that it gathered the information it pro- .Supplier acknowledges that Company e relied on informationprovided by othe v others, Supplier agrees that, at a minin and the Supplier enter into a written agre pource of the Supplier's liability and the	henyl ethers (each a " ndicate below which, i ovides in this form us will rely on this certifiers in completing this num, itssuppliers have eement with respect to Company's remedies	RoHS restricted substance") in exce if any, RoHS exemption you believe ing appropriate methods to ensure if ication in determining the complian form, and that Supplier may not have e provided certifications regarding the to the identified part, the terms and co for issues that arise regarding inform	ce of its products with European Union membe	ove. If a homogeneous material within the part er level components, the declaration shall l correct to the best of its knowledge and belief, r state laws that implement the RoHS Directive. wever, in situations where Supplier has not tions are at least as comprehensive as the anty rights and/or remedies provided as part of					
RoHS Declaration * 1 - Item(s)	does not contain RoHS restricted substa	ances per the definitio	on above	Supplier Acceptance	* Accepted					
Exemption: If the declared item does not con applicable exemptions.	ntain RoHS restricted substances per	the definition above	except for defined RoHS exempti	ons, then select the corresponding response i	n the RoHS Declaration above and choose all					
Exemption List Version	EL-2011/534/EU									
Declaration Signature										
Instructions: Complete all of the required fin Requester) and click on Submit Form to have	elds on all pages of this form. Select the form returned to the Requester	he "Accepted" on th	e Supplier Acceptance drop-down	. This will display the signature area. Digital	lly sign the declaration (if required by the					
Supplier Digital Signature Ra	stislav Drska	Le								

Homogeneous Material Composition Declaration for Electronic Products

SubItem Instructions: The presence of any JIG Level A or B substances must be declared. [1] indicate the subpart in which the substance is located, [2] provide a description of the homogeneous material [3], enter the weight of the homogeneous material.

Homogeneous Material	Weight	Unit of Measure	Level	Substance	CAS	Exempt	Weight	Unit of Measure
Die	3.79	mg	Supplier	Silicon (Si)	7440-21-3		3.79	mg
Die Attach	24.58	mg	Supplier	Silver (Ag)	7440-22-4		18.435	mg
			Supplier	Epoxy resins	129915-35-1		6.145	mg
Lead Frame 3	385.08	mg	Supplier	Silver (Ag)	7440-22-4		2.6956	mg
			Supplier	Zinc (Zn)	7440-66-6		0.4621	mg
			Supplier	Iron (Fe)	7439-89-6		9.0494	mg
			Supplier	Copper (Cu)	7440-50-8		372.7574	mg
			Supplier	Phosphorus (P)	7723-14-0		0.1155	mg
Mold Compound-Black	242.16	mg		Epoxy Phenol Resin	proprietary data		25.4268	mg
			Supplier	Fused Silica (SiO2)	60676-86-0		216.7332	mg
Plating	5.6	mg	Supplier	Tin (Sn)	7440-31-5		5.6	mg
Wire Bond - Cu	0.57	mg	Supplier	Copper (Cu)	7440-50-8		0.57	mg